



Product Change Notification

Change Notification #: 117698 - 00
Change Title: Intel® Server Chassis R2312WFXXX, PCN 117698-00, Product Design, Label, 3.5" Tool-less Carrier Design Improvement for 2.5" Drive Support and Packaging Regulatory Label Update
Date of Publication: July 20, 2020

Key Characteristics of the Change:

Product Design, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	August 4, 2020
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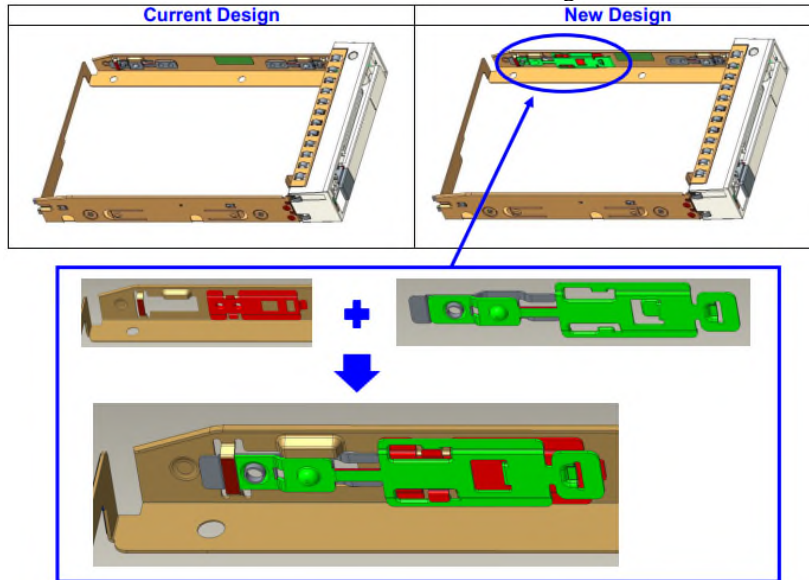
* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Chassis R2312WFXXX listed in the "Products Affected" table below:

- Improving the 3.5" drive tool-less carrier (TLC) when used with 2.5" Solid State Drives (SSD), from a non-removable to a new removable rear spring (images below) which avoids the need of screwdriver to remove the SSD.
- Packaging Regulatory Labels have been updated by removing Vietnam Logo and adding NYCE Logo (images below).

Current and New Design



Before Labels

Common Regulatory Label



Packaging Regulatory Label



After Labels

Common Regulatory Label



Packaging Regulatory Label



Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes but encourages customers to understand the change and determine the impact on their applications. For that reason, Intel recommends that the customer perform a standard level of evaluation.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R2312WFXXX	952624	H81038-004	H81038-005

PCN Revision History:

Date of Revision:
July 20, 2020

Revision Number:
00

Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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